


IN THE SPECIFICATION:

Applicants have discovered a typographical error in the amendment made in the Preliminary Amendment of August 10, 2001 to the paragraph beginning at page 14, line 19 of the originally filed Specification. In particular, the angled portion of the solder conductive pad of contact 470 is incorrectly referred to as element "456." The correct reference numeral is "457," as is apparent from Figure 33 (as previously amended). Accordingly, Applicants respectfully request that the paragraph submitted in the Preliminary Amendment of August 10, 2001 to replace the originally submitted paragraph at page 14, line 19, be replaced with the following corrected paragraph (a version with markings to show changes made is attached hereto):

 -- Referring to Figures 28-31, a receptacle which mates with the plug 420 is shown generally at numeral 456. This receptacle includes a base section dielectric 458, a peripheral bevelled edge 460 and rows of metallic pin receiving recesses as at 462, 464, 466, 468 and 470. Metallic grounding or power elements receiving structures 472, 474, 476, 478, 480 and 482 are interposed between the rows of pin receiving recesses. On its bottom, or mounting, side the receptacle also includes alignment and mounting pins 484 and 486 which enter corresponding openings (not shown) in a substrate (not shown) during mounting. Further, the bottom side of the receptacle includes rows of solder conductive pads to which solder masses, such as the solder balls 488 and 490 shown in Figure 30, secure (*i.e.*, are fused). As seen in Figure 33, the solder conductive pad of contact 470 is an angled portion 457 which resides in a recess 459 in the base. As customary in ball grid array assemblies, solder balls 488, 490, once reflowed, secure receptacle 456 to a substrate (not shown). From Figures 32-33 it will be observed that the same I-beam geometry as was described above is available with this arrangement. --

REMARKS

Claims 1, 2, 4-20, and 22-45 were pending in this application as of the date of the Office Action. Applicants have canceled claims 18-20, 22-40, and 43-45 without prejudice. Claims 1, 2, 4-17, 41 and 42 remain pending.